



SINGLE P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

| BV _{DSS} | R _{DS(ON)} max | I _D max T _A = +25°C |
|-------------------|--------------------------------|--|
| | 14mΩ @ V _{GS} = -10V | -12.0A |
| -30V | 25mΩ @ V _{GS} = -4.5V | -8.5A |

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Backlighting
- Power Management Functions
- DC-DC Converters

Features

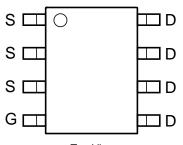
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

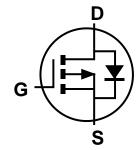
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Lead Frame. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074g (Approximate)



Top View



Top View Internal Schematic



Equivalent Circuit

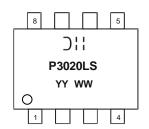
Ordering Information (Note 4)

| Part Number | Case | Packaging |
|---------------|------|------------------|
| DMP3020LSS-13 | SO-8 | 2500/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



);; = Manufacturer's Marking
P3020LS = Product Type Marking Code
YYWW = Date Code Marking
YY or YY = Year (ex: 16 = 2016)
WW = Week (01 to 53)



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

| Characteristic | | | Symbol | Value | Unit |
|-------------------------------|-----------------|----------------------------------|------------------|-----------|------|
| Drain-Source Voltage | | | V _{DSS} | -30 | V |
| Gate-Source Voltage | | | V _{GSS} | ±25 | V |
| Drain Current (Note 5) | Steady State | $T_A = +25$ °C $T_A = +70$ °C | ID | -12 -9 | А |
| Pulsed Drain Current (Note 6) | | | I _{DM} | -80 | Α |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|------------------|-------------|------|
| Total Power Dissipation (Note 5) | P_{D} | 2.5 | W |
| Thermal Resistance, Junction to Ambient | $R_{	hetaJA}$ | 50 | °C/W |
| Operating and Storage Temperature Range | $T_{J_i}T_{STG}$ | -55 to +150 | °C |

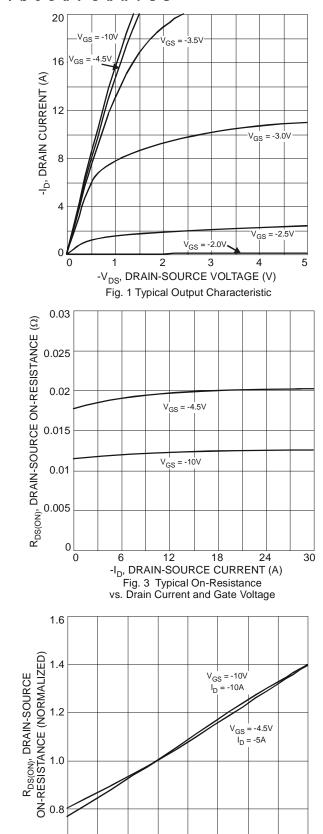
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|-----------------------------------|---------------------|------|---------|------|--|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | -30 | _ | _ | V | $V_{GS} = 0V, I_D = -250\mu A$ |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | _ | -1 | μA | $V_{DS} = -30V, V_{GS} = 0V$ |
| Cata Sauraa Laakaga | | _ | _ | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ |
| Gate-Source Leakage | I _{GSS} | _ | _ | ±800 | | $V_{GS} = \pm 25V, V_{DS} = 0V$ |
| ON CHARACTERISTICS (Note 7) | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | -1 | _ | -2 | V | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ |
| Static Drain-Source On-Resistance | D | _ | 11.6 14 | 14 | mΩ | $V_{GS} = -10V, I_D = -8A$ |
| Static Drain-Source On-Resistance | R _{DS(ON)} | | 18.6 | 25 | 11122 | $V_{GS} = -4.5V, I_D = -5A$ |
| Forward Transconductance | 9 _{fs} | | 12 | _ | S | $V_{DS} = -10V, I_{D} = -12A$ |
| Diode Forward Voltage (Note 7) | V_{SD} | -0.5 | _ | -1.1 | V | $V_{GS} = 0V, I_{S} = -2A$ |
| DYNAMIC CHARACTERISTICS | | | | | | |
| Input Capacitance | C _{iss} | | 1802 | _ | pF | |
| Output Capacitance | Coss | _ | 415 | _ | pF V _{DS} = -15V, V _{GS} = 0V, f = 1 | $V_{DS} = -15V$, $V_{GS} = 0V$, $f = 1.0MHz$ |
| Reverse Transfer Capacitance | C _{rss} | _ | 295 | _ | pF | |
| Gate Resistance | R_{G} | _ | 2.3 | _ | Ω | $V_{GS} = 0V$, $V_{DS} = 0V$, $f = 1MHz$ |
| SWITCHING CHARACTERISTICS | | | | | | |
| Total Gate Charge | Qg | _ | 15.3 | | nC | $V_{DS} = -15V$, $V_{GS} = -4.5V$, $I_{D} = -8A$ |
| Total Gate Charge | | | 30.7 | | | $V_{DS} = -15V$, $V_{GS} = -10V$, $I_{D} = -8A$ |
| Gate-Source Charge | Q_{gs} | | 3.5 | _ | | $V_{DS} = -15V$, $V_{GS} = -10V$, $I_{D} = -8A$ |
| Gate-Drain Charge | Q_{gd} | | 7.9 | _ | | $V_{DS} = -15V$, $V_{GS} = -10V$, $I_{D} = -8A$ |
| Turn-On Delay Time | t _{D(ON)} | _ | 5.1 | _ | | |
| Rise Time | t _R | _ | 8 | _ | | $V_{GS} = -10V, V_{DS} = -15V,$ |
| Turn-Off Delay Time | t _{D(OFF)} | _ | 46 | _ | ns | $R_D = 15\Omega$, $R_G = 6\Omega$ |
| Fall Time | t _F | 1 | 30 | _ | | |

5. Device mounted on 2 oz. copper pads on FR-4 PCB with $R_{\theta JA}$ = 50°C/W. Notes:

^{6.} Pulse width ≤10µs, Duty Cycle ≤1%.
7. Short duration pulse test used to minimize self-heating effect.







50

75

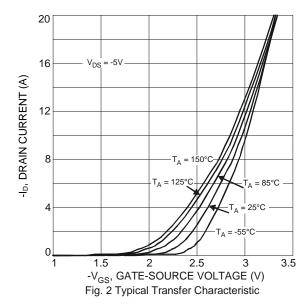
25

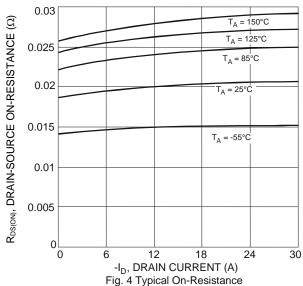
 $V_{GS} = -4.5V$

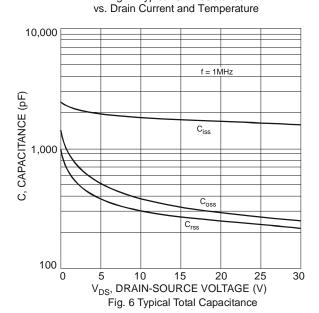
I_D = -5A

100

125







0.6



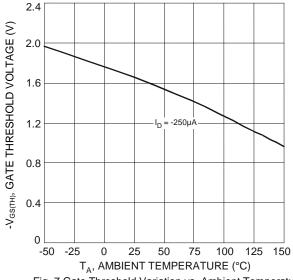


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

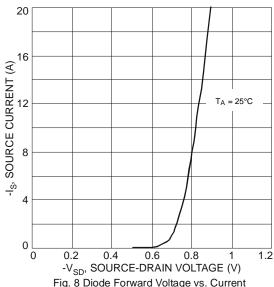
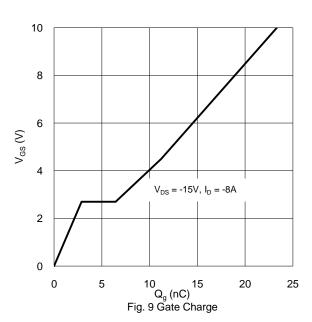


Fig. 8 Diode Forward Voltage vs. Current



100 $\begin{array}{c} R_{\text{DS(ON)}} \\ \text{Limited} \end{array}$ 10 I_D, DRAIN CURRENT (A) 0.1 T_{J(Max)} = 150°C $T_C = 25^{\circ}C$ Single Pulse $P_W = 10ms$ DUT on 1*MRP Board $V_{GS} = -10V$ 0.01 $\begin{array}{ccc} & & 1 & 10 \\ V_{\rm DS}, \, {\rm DRAIN\text{-}SOURCE} \,\, {\rm VOLTAGE} \,\, ({\rm V}) \\ {\rm Fig.} \,\, 10 \,\, {\rm SOA}, \, {\rm Safe} \,\, {\rm Operation} \,\, {\rm Area} \end{array}$ 0.1 100

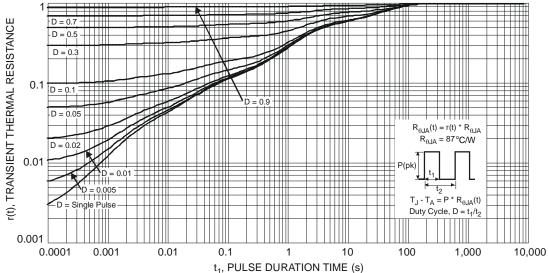


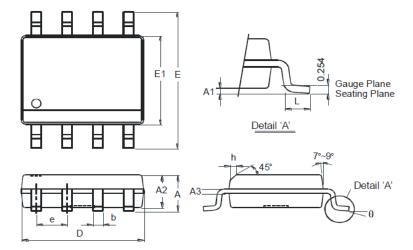
Fig. 11 Transient Thermal Response



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8

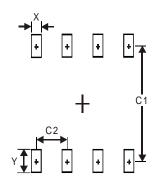


| SO-8 | | | | |
|----------------------|----------|------|--|--|
| Dim | Min | Max | | |
| Α | - | 1.75 | | |
| A1 | 0.10 | 0.20 | | |
| A2 | 1.30 | 1.50 | | |
| A3 | 0.15 | 0.25 | | |
| b | 0.3 | 0.5 | | |
| D | 4.85 | 4.95 | | |
| Е | 5.90 | 6.10 | | |
| E1 | 3.85 | 3.95 | | |
| е | 1.27 Typ | | | |
| h | - | 0.35 | | |
| L | 0.62 | 0.82 | | |
| θ | 0° | 8° | | |
| All Dimensions in mm | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8



| Dimensions | Value (in mm) |
|------------|---------------|
| Х | 0.60 |
| Υ | 1.55 |
| C1 | 5.4 |
| C2 | 1 27 |

June 2016



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